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- State-of-the-Art *EPIC*-II*B*<sup>™</sup> BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- High-Drive Outputs (–32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Plastic (N) and Ceramic (J) DIPs, and Ceramic Flat (W) Package

#### description

These 8-bit flip-flops with 3-state outputs are designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK), the  $\overline{Q}$  outputs are set to the complement of the logic levels set up at the data (D) inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect the internal operations of the flip-flop. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT534 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74ABT534A is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

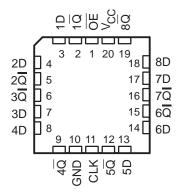
EPIC-IIB is a trademark of Texas Instruments Incorporated

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



| SN54ABT534 J OR W PACKAGE            |  |  |  |  |  |  |  |  |  |  |  |
|--------------------------------------|--|--|--|--|--|--|--|--|--|--|--|
| SN74ABT534A DB, DW, N, OR PW PACKAGE |  |  |  |  |  |  |  |  |  |  |  |
| (TOP VIEW)                           |  |  |  |  |  |  |  |  |  |  |  |

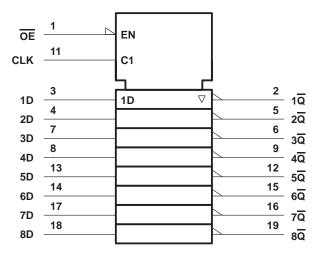
SN54ABT534 . . . FK PACKAGE (TOP VIEW)



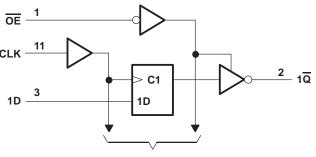
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| FUNCTION TABLE<br>(each flip-flop) |  |  |  |  |  |  |  |  |  |  |
|------------------------------------|--|--|--|--|--|--|--|--|--|--|
| INPUTS                             | Ου <u>τ</u> ρυτ                              |  |  |  |  |  |  |  |  |  |
| CLK                                | Q  |  |  |  |  |  |  |  |  |  |
| Ŷ                                  | Н  | L  |  |  |  |  |  |  |  |  |
| Ŷ                                  | L  | н  |  |  |  |  |  |  |  |  |
| H or L                             | Х  | $\overline{Q}_0$   |  |  |  |  |  |  |  |  |
| Х                                  | Х  | z  |  |  |  |  |  |  |  |  |
|                                    | (each f<br>INPUTS<br>CLK<br>↑<br>↑<br>H or L | (each flip-flop<br>INPUTS<br>CLK D<br>↑ H<br>↑ L<br>H or L X |  |  |  |  |  |  |  |  |

logic symbol<sup>†</sup>



logic diagram (positive logic)



**To Seven Other Channels** 

<sup>+</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage range, V <sub>CC</sub><br>Input voltage range, V <sub>I</sub> (see Note 1)<br>Voltage range applied to any output in the high or power-off state | –0.5 V to 7 V  |
|---|----------------|
|   |                |
| Current into any output in the low state, IO: SN54ABT534  |                |
| SN74ABT534A   | 128 mA         |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)   | –18 mA         |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)  |                |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package   | 115°C/W        |
| DW package  |                |
| N package   |                |
| PW package  | 128°C/W        |
| Storage temperature range, T <sub>stg</sub>   | –65°C to 150°C |

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51, except for through-hole packages, which use a trace length of zero.



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### recommended operating conditions (see Note 3)

|                     |                                    |  | SN54A | BT534 | SN74AB | UNIT |      |
|---------------------|------------------------------------|--|-------|-------|--------|------|------|
|                     |                                    |  |       | MAX   | MIN    | MAX  | UNIT |
| Vcc                 | Supply voltage                     | 4.5  | 5.5   | 4.5   | 5.5    | V    |      |
| VIH                 | High-level input voltage           | 2  |       | 2     |        | V    |      |
| VIL                 | Low-level input voltage            |  | 0.8   |       | 0.8    | V    |      |
| VI                  | Input voltage                      |  | 0     | VCC   | 0      | VCC  | V    |
| ЮН                  | High-level output current          |  |       | -24   |        | -32  | mA   |
| IOL                 | Low-level output current           |  |       | 48    |        | 64   | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | out transition rise or fall rate Outputs enabled |       |       |        | 5    | ns/V |
| ТА                  | A Operating free-air temperature   |  |       |       | -40    | 85   | °C   |

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  | TEST CONDITIONS   |                                    |                        | ٦   | Γ <sub>A</sub> = 25°0 | )     | SN54A | BT534 | SN74AB |       |      |
|------------------|---|------------------------------------|------------------------|-----|-----------------------|-------|-------|-------|--------|-------|------|
| PARAMETER        |   | TEST CONDITIONS                    |                        |     |                       | MAX   | MIN   | MAX   | MIN    | MAX   | UNIT |
| VIK              | V <sub>CC</sub> = 4.5 V,                                  | lı = -18 mA                        |                        |     |                       | -1.2  |       | -1.2  |        | -1.2  | V    |
|                  | V <sub>CC</sub> = 4.5 V,                                  | IOH = -3 mA                        |                        | 2.5 |                       |       | 2.5   |       | 2.5    |       |      |
| Vari             | V <sub>CC</sub> = 5 V,                                    | IOH = -3 mA                        |                        | 3   |                       |       | 3     |       | 3      |       | V    |
| VOH              | V <sub>CC</sub> = 4.5 V                                   | $I_{OH} = -24 \text{ m/}$          | 4                      | 2   |                       |       | 2     |       |        |       | v    |
|                  | VCC = 4.3 V   | I <sub>OH</sub> = -32 m/           | 4                      | 2*  |                       |       |       |       | 2      |       |      |
| Ve               |   | I <sub>OL</sub> = 48 mA            |                        |     |                       | 0.55  |       | 0.55  |        |       | V    |
| VOL              | V <sub>CC</sub> = 4.5 V                                   | I <sub>OL</sub> = 64 mA            |                        |     |                       | 0.55* |       |       |        | 0.55  | v    |
| V <sub>hys</sub> |   |                                    |                        |     | 100                   |       |       |       |        |       | mV   |
| I                | V <sub>CC</sub> = 5.5 V,                                  | $V_{I} = V_{CC} \text{ or } C$     | GND                    |     |                       | ±1    |       | ±1    |        | ±1    | μΑ   |
| IOZH             | V <sub>CC</sub> = 5.5 V,                                  | V <sub>O</sub> = 2.7 V             | V <sub>O</sub> = 2.7 V |     |                       | 10‡   |       | 10‡   |        | 10‡   | μΑ   |
| IOZL             | V <sub>CC</sub> = 5.5 V,                                  | $V_{O} = 0.5 V$                    | V <sub>O</sub> = 0.5 V |     |                       | -10‡  |       | -10‡  |        | -10‡  | μΑ   |
| loff             | $V_{CC} = 0,$   | $V_{I} \text{ or } V_{O} \leq 4.5$ | 5 V                    |     |                       | ±100  |       |       |        | ±100  | μΑ   |
| ICEX             | V <sub>CC</sub> = 5.5 V,                                  | V <sub>O</sub> = 5.5 V             | Outputs high           |     |                       | 50    |       | 50    |        | 50    | μΑ   |
| ١O§              | V <sub>CC</sub> = 5.5 V,                                  | V <sub>O</sub> = 2.5 V             |                        | -50 | -100                  | -180‡ | -50   | -180‡ | -50    | -180‡ | mA   |
|                  |   | _                                  | Outputs high           |     | 1                     | 250   |       | 250   |        | 250   | μΑ   |
| ICC              | $V_{CC} = 5.5 V, I_{C}$<br>$V_{I} = V_{CC} \text{ or } G$ |                                    | Outputs low            |     | 24                    | 30    |       | 30    |        | 30    | mA   |
|                  |   |                                    | Outputs disabled       |     | 0.5                   | 250   |       | 250   |        | 250   | μΑ   |
| ∆ICC¶            | V <sub>CC</sub> = 5.5 V, C<br>Other inputs at             | V,                                 |                        |     | 1.5                   |       | 1.5   |       | 1.5    | mA    |      |
| Ci               | VI = 2.5 V or 0.  | .5 V                               |                        |     | 3.5                   |       |       |       |        |       | pF   |
| Co               | V <sub>O</sub> = 2.5 V or 0                               | 0.5 V                              |                        |     | 6.5                   |       |       |       |        |       | pF   |

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

<sup>†</sup> All typical values are at  $V_{CC} = 5 V$ .

<sup>‡</sup> This data sheet limit may vary among suppliers.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.



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#### timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

|                 |  |                 |                   | SN54A          | BT534 |     |      |
|-----------------|--|-----------------|-------------------|----------------|-------|-----|------|
|                 |  |                 | V <sub>CC</sub> = | = 5 V,<br>25°C | MIN   | МАХ | UNIT |
|                 |  |                 |                   |                |       |     |      |
| fclock          | Clock frequency                          |                 |                   | 125            |       | 125 | MHz  |
| tw              | Pulse duration                           | CLK high or low | 3.5               |                | 3.5   |     | ns   |
| t <sub>su</sub> | Setup time, data before CLK <sup>↑</sup> | High or low     | 1.6               |                | 1.6   |     | ns   |
| t <sub>h</sub>  | Hold time, data after $CLK^\uparrow$     | High or low     | 1.6               |                | 1.6   |     | ns   |

#### timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

|                 |  |                 |     | SN74AE | 3T534A |     |      |
|-----------------|--|-----------------|-----|--------|--------|-----|------|
|                 |  |                 |     |        | MIN    | МАХ | UNIT |
|                 |  |                 | MIN | MAX    |        |     | L    |
| fclock          | Clock frequency                          |                 |     | 125    |        | 125 | MHz  |
| tw              | Pulse duration                           | CLK high or low | 3.5 |        | 3.5    |     | ns   |
| t <sub>su</sub> | Setup time, data before CLK <sup>↑</sup> | High or low     | 1.6 |        | 1.6    |     | ns   |
| t <sub>h</sub>  | Hold time, data after CLK↑               | High or low     | 2†  |        | 2†     |     | ns   |

<sup>†</sup> This data sheet limit may vary among suppliers.

#### switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V(<br>Tj | CC = 5 V<br>A = 25°C | l,<br>; | MIN | МАХ | UNIT |
|------------------|-----------------|----------------|----------|----------------------|---------|-----|-----|------|
|                  |                 |                | MIN      | TYP                  | MAX     |     |     |      |
| fmax             |                 |                | 125      | 175                  |         | 125 |     | MHz  |
| tPLH             | CLK             | -              | 2.6      | 4.5                  | 6.1     | 2.6 | 7   | ns   |
| <sup>t</sup> PHL | OEK             | Q              | 3.4      | 5.5                  | 6.7     | 3.4 | 7.9 | 113  |
| <sup>t</sup> PZH | OE              | ā              | 1        | 3.4                  | 5.2     | 1   | 5.8 | ns   |
| tPZL             | ÛE              | Q              | 2.6      | 4                    | 5.8     | 2.6 | 7   | 115  |
| <sup>t</sup> PHZ | OE              | ā              | 2.4      | 4.7                  | 6.6     | 2.4 | 7.6 | ns   |
| <sup>t</sup> PLZ | ÛE              | Q              | 2.3      | 3.8                  | 5.8     | 2.3 | 6.8 | 115  |



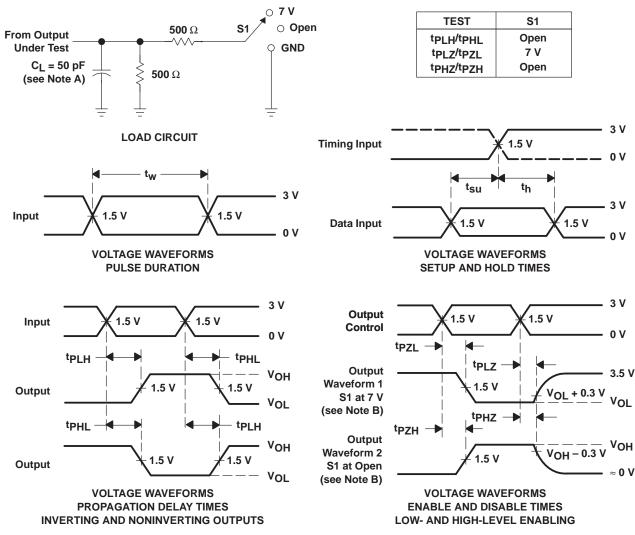
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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | Vo<br>Tj | CC = 5 V<br>A = 25°C | l,<br>; | MIN | МАХ | UNIT |
|------------------|-----------------|----------------|----------|----------------------|---------|-----|-----|------|
|                  |                 |                | MIN      | TYP                  | MAX     |     |     |      |
| fmax             |                 |                | 125      | 175                  |         | 125 |     | MHz  |
| tPLH             |                 | CLK Q          |          | 4.5                  | 5.9     | 2.6 | 6.7 | ns   |
| t <sub>PHL</sub> | OER             | Q              | 3.4      | 5.5                  | 6.7     | 3.4 | 7.6 | 113  |
| <sup>t</sup> PZH | OE              | Q              | 1        | 3.4                  | 4.2     | 1   | 5   | ns   |
| tPZL             | ÛE              | Q              | 2.6      | 4                    | 5.8     | 2.6 | 6.8 | 115  |
| <sup>t</sup> PHZ | OE              | Q              | 2.4      | 4.7                  | 6.6     | 2.4 | 7.3 | ns   |
| <sup>t</sup> PLZ | UE              | Q              | 2.3      | 3.8                  | 5.8     | 2.3 | 6.5 |      |



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### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns. t<sub>f</sub>  $\leq$  2.5 ns.

D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finis | n MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|-----------------|--------------------------------|
| 5962-9314701Q2A  | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                       | POST-PLATE      | N / A for Pkg Type             |
| 5962-9314701QRA  | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                       | A42 SNPB        | N / A for Pkg Type             |
| 5962-9314701QSA  | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                       | Call TI         | N / A for Pkg Type             |
| SN74ABT534ADBLE  | OBSOLETE              | SSOP            | DB                 | 20   |                | TBD                       | Call TI         | Call TI                        |
| SN74ABT534ADBR   | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADBRE4 | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADBRG4 | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADW    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADWE4  | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADWG4  | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADWR   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADWRE4 | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ADWRG4 | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534AN     | ACTIVE                | PDIP            | Ν                  | 20   | 20             | Pb-Free<br>(RoHS)         | CU NIPDAU       | N / A for Pkg Type             |
| SN74ABT534ANE4   | ACTIVE                | PDIP            | Ν                  | 20   | 20             | Pb-Free<br>(RoHS)         | CU NIPDAU       | N / A for Pkg Type             |
| SN74ABT534ANSR   | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ANSRE4 | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534ANSRG4 | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534APW    | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534APWE4  | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534APWG4  | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534APWLE  | OBSOLETE              | TSSOP           | PW                 | 20   |                | TBD                       | Call TI         | Call TI                        |
| SN74ABT534APWR   | ACTIVE                | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534APWRE4 | ACTIVE                | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SN74ABT534APWRG4 | ACTIVE                | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU       | Level-1-260C-UNLIM             |
| SNJ54ABT534FK    | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                       | POST-PLATE      | N / A for Pkg Type             |
| SNJ54ABT534J     | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                       | A42 SNPB        | N / A for Pkg Type             |
| SNJ54ABT534W     | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                       | Call TI         | N / A for Pkg Type             |
|                  |                       |                 |                    |      |                |                           |                 |                                |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### OTHER QUALIFIED VERSIONS OF SN54ABT534 :

Catalog: SN74ABT534

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

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### TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

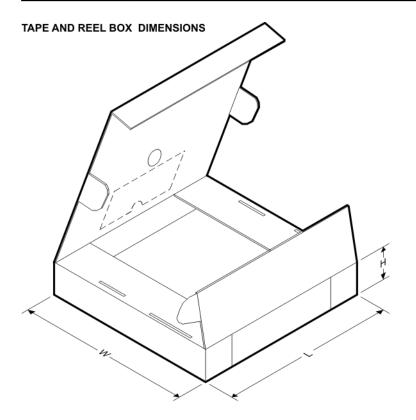


| Device         |       | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|-------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74ABT534ADBR | SSOP  | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2     | 7.5     | 2.5     | 12.0       | 16.0      | Q1               |
| SN74ABT534ADWR | SOIC  | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8    | 13.0    | 2.7     | 12.0       | 24.0      | Q1               |
| SN74ABT534ANSR | SO    | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.2     | 13.0    | 2.5     | 12.0       | 24.0      | Q1               |
| SN74ABT534APWR | TSSOP | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95    | 7.1     | 1.6     | 8.0        | 16.0      | Q1               |



# PACKAGE MATERIALS INFORMATION

5-Aug-2008



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT534ADBR | SSOP         | DB              | 20   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74ABT534ADWR | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74ABT534ANSR | SO           | NS              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74ABT534APWR | TSSOP        | PW              | 20   | 2000 | 346.0       | 346.0      | 33.0        |

# **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MLCC006B - OCTOBER 1996

### FK (S-CQCC-N\*\*)

#### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



### MECHANICAL DATA

### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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